- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

description

These devices contain two independent 4-input positive NOR gates. They perform the Boolean functions:

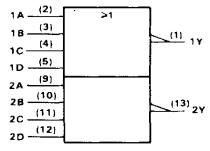
 $Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}$ or $Y = \overline{A} \cdot \overline{B} \cdot \overline{C} \cdot \overline{D}$ in positive logic.

The SN54HC4002 is characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to $125\,^{\circ}\text{C}$. The SN74HC4002 is characterized for operation from $-40\,^{\circ}\text{C}$ to $85\,^{\circ}\text{C}$.

FUNCTION TABLE

	INP	UTS		OUTPUT
A	В	С	D	[Y
Н	Х	Х	Х	Ĺ.
x	Н	Х	Х	L
x	Х	н	X	l L
X	Х	Х	Н	L
L	L	L	L	н

logic symbol†

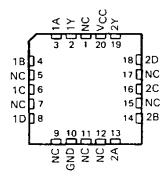


[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

SN54HC4002 . . . J PACKAGE SN74HC4002 . . . D OR N PACKAGE (TOP VIEW)

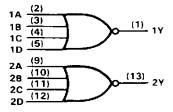
1Y [U14DVCC 1A 🗌 13 2Y 18 □ 12 2D 3 1C [14 11 2C 1D 🛮 5 10 2B NC ☐6 9 2A GND □7 8∏NC

SN54HC4002 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

logic diagram (positive logic)



Pin numbers shown are for D, J, and N packages.

absolute maximum ratings over operating free-air temperature range[†]

Supply voltage range, VCC	-0.5	V to 7 V
Input clamp current, IjK (VI < 0 or VI $> VCC$)		± 20 mA
Output clamp current, IOK (VO < 0 or VO > VCC)		± 20 mA
Continuous output current, IO (VO = 0 to VCC)		± 25 mA
Continuous current through VCC or GND pins		± 50 mA
Lead temperature 1,6 mm (1/16 in) from case for 60 s: FK or J package		
Lead temperature 1,6 mm (1/16 in) from case for 10 s: D or N package		
Storage temperature range6		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			Sh	SN54HC4002		SN	UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX	ONIT
Vcc	Supply voltage		2	5	6	2	5	6	>
		V _{CC} = 2 V	1.5			1.5			
ViH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			٧
		V _{CC} = 6 V	4.2			4.2			
		V _{CC} = 2 V	0		0.3	0		0.3	
V_{IL}	Low-level input voltage	V _{CC} = 4.5 V	0		0.9	0		0.9	V
		V _{CC} = 6 V	0		1.2	0		0.3	
V _I	Input voltage		0		Vcc	0		V _{CC} _	٧
Vo	Output voltage		0		VCC	0		Vcc	V
		V _{CC} = 2 V	0		1000	0		1000	
tt	Input transition (rise and fall) times	$V_{CC} = 4.5 \text{ V}$	0		500	0		500	กร
-		V _{CC} = 6 V	0		400	0		400	
TΑ	Operating free-air temperature		- 55		125	-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		VCC TA = 25°C		SN54F	IC4002	SN74H	C4002	UNIT		
PARAMETER	TEST CONDITIONS	V _{CC}	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
		2 V	1.9	1.998		1.9		1.9		
1	$V_{I} = V_{IH}$ or V_{IL} , $I_{OH} = -20 \mu A$	4.5 V	4.4	4.499		4.4		4.4		
∨oн [6 V	5.9	5.999		5.9	_	5.9		V
	$V_l = V_{lH}$ or V_{lL} , $I_{OH} = -4$ mA	4.5 V	3.98	4.30	· ·	3.7		3.84		
Ì	$V_{\parallel} = V_{\parallel H}$ or $V_{\parallel L}$, $I_{OH} = -5.2$ mA	6 V	5.48	5.80	12.0	5.2		5.34		
		2 V		0.002	0.1		0.1		0.1	
	$V_{I} = V_{IH}$ or V_{IL} , $I_{OL} = 20 \mu A$	4.5 V		0.001	0.1		0.1]	0.1	
VOL		6 V		0.001	0.1		0.1		0.1	٧
	VI = VIH or VIL, IOL = 4 mA	4.5 V		0.17	0.26		0.4		0.33	
1	VI = VIH or VIL, IOL = 5.2 mA	6 V		0.15	0.26	1	0.4		0.33	
I _I	V _I = V _{CC} or 0	6 V		±0.1	±100		± 1000	±	1000	nA
^l cc	$V_I = V_{CC}$ or 0, $I_{O} = 0$	6 V			2		40		20	μΑ
C _i		2 to 6 V		3	10	<u> </u>	10		10	pF

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), $C_L = 50 \text{ pF}$ (see Note 1)

DADAMETER	FROM	TO		TA = 25°C			\$N54HC4002		SN74HC4002		UNIT
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONL
	-		2 V		44	110		165		140	
t _{pd}	A thru D	Y	4.5 V		12	22		33		28	ns
			6 V	l	11	19		28		24	
			2 V		38	75		110		95	I
tt		Y	4.5 V		8	15		22		19	กร
ŀ			6 V	1	6	13	ļ	19		16	

€ _{pd}	Power dissipation capacitance per gate	No load, T _A = 25°C	25 pF typ

Note 1: Load circuits and voltage waveforms are shown in Section 1.





6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	_	Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
84044012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	84044012A SNJ54HC 4002FK	Samples
8404401CA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8404401CA SNJ54HC4002J	Samples
JM38510/65104BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 65104BCA	Samples
M38510/65104BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 65104BCA	Samples
SN54HC4002J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54HC4002J	Samples
SNJ54HC4002FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	84044012A SNJ54HC 4002FK	Samples
SNJ54HC4002J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8404401CA SNJ54HC4002J	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



PACKAGE OPTION ADDENDUM

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a certain is using glass int.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



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